

**Amendments to the specification:**

On page 2, please amend the third paragraph as follows:

It is especially advantageous if the printed circuit board with the relatively vulnerable electronic circuit is located on the side of the housing frame opposite facing away from the housing bottom. As a result, a considerably greater power loss can be dissipated, since the connection between the housing frame and the housing bottom can be designed over a large surface area, and a high number of connecting points (screw connections) can also be provided. The available surface area for the printed circuit board layout is relatively large, since the printed circuit board is not interrupted by recesses that are otherwise needed for purposes of heat dissipation.